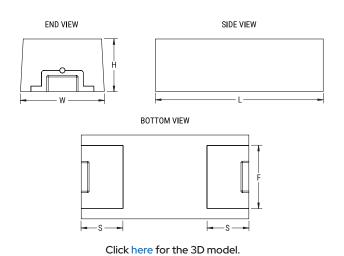


T527S336M016ATE200

Aliases (TEFPSA21C336M8R)

T527, Tantalum, Polymer Tantalum, Reduced Volume, 33 uF, 20%, 16 VDC, SMD, Polymer, Molded, Face Down Terminals, 200 mOhms, 3216, 1.2 mm,



General Information	
Series	T527
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Face Down Terminals
Features	Face Down, Low Profile, Low ESR
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	26.2 mg
Shelf Life	52 Weeks
MSL	4

33 uF

(rms, 105C)

54 uA (5min 25°C)

Dimensions	
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Н	1.1mm +/-0.1mm
S	0.8mm +/-0.2mm
F	1.2mm +/-0.1mm

	1.6mm +/-0.2mm	Tolerance	20%
	1.1mm +/-0.1mm	Voltage DC	16 VDC (105C)
	0.8mm +/-0.2mm	Temperature Range	-55/+105°C
1.2mm +/-0.1mm		Rated Temperature	105°C
		Life	1000 Hrs (105C)
ns		Humidity	60C, 90% RH, 500 Hours, No Load
	T&R, 178mm		LOad
	3000	Dissipation Factor	10% 120Hz 25C
		Failure Rate	N/A
		ESR	200 mOhms (100kHz 25C)
	Ripple Current	548 mA (rms, 100kHz 45C), 383.6 mA (rms, 85C), 137 mA	

Leakage Current

Specifications

Capacitance

F 1.2mm +/-0.1mm		Rated Temperature	105°C
		Life	1000 Hrs
Packaging Specifications		Humidity	60C, 90°
Packaging	T&R, 178mm		Load
Packaging Quantity	3000	Dissipation Factor	10% 120H
		Failure Rate	N/A
		FSR	200 mOl

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 08/24/2025 © 2006 - 2025 YAGEO



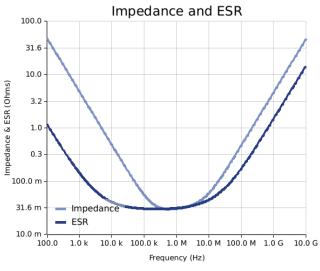
T527S336M016ATE200

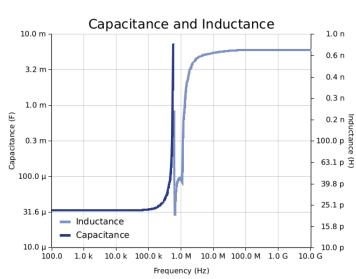
Aliases (TEFPSA21C336M8R)

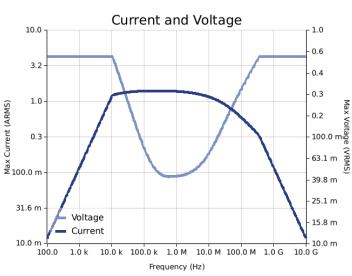
T527, Tantalum, Polymer Tantalum, Reduced Volume, 33 uF, 20%, 16 VDC, SMD, Polymer, Molded, Face Down Terminals, 200 mOhms, 3216, 1.2 mm, 0.8 mm

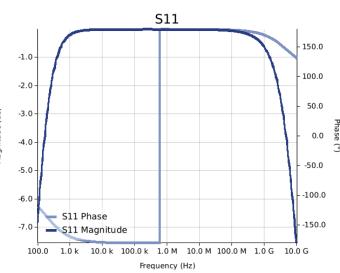
Simulations

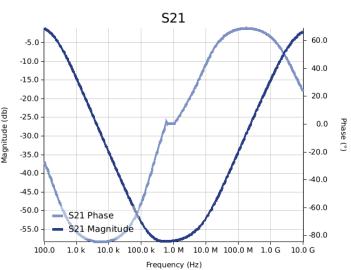
For the complete simulation environment please visit Y-SIM.











Generated 08/24/2025 © 2006 - 2025 YAGEO



T527S336M016ATE200

Aliases (TEFPSA21C336M8R)

T527, Tantalum, Polymer Tantalum, Reduced Volume, 33 uF, 20%, 16 VDC, SMD, Polymer, Molded, Face Down Terminals, 200 mOhms, 3216, 1.2 mm,

These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated. The effects shown herein are based on measured data from a multiple part sample of the parts in question.

 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages
- generated at any other harmonics.

 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.

Generated 08/24/2025 © 2006 - 2025 YAGEO